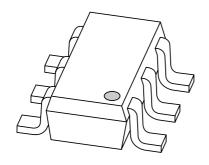
DISCRETE SEMICONDUCTORS

DATA SHEET



PMEM4010ND NPN transistor/Schottky diode module

Product specification

2002 Oct 28





NPN transistor/Schottky diode module

PMEM4010ND

FEATURES

- 600 mW total power dissipation
- · High current capability
- · Reduces required PCB area
- · Reduced pick and place costs
- Small plastic SMD package.

Transistor:

· Low collector-emitter saturation voltage.

Diode:

- · Ultra high-speed switching
- · Very low forward voltage
- · Guard ring protected.

APPLICATIONS

- DC/DC convertors
- · Inductive load drivers
- · General purpose load drivers
- Reverse polarity protection circuits.

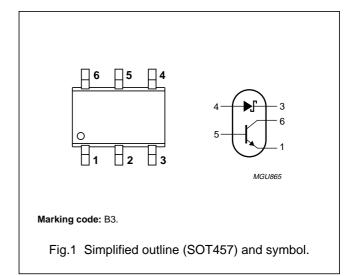
DESCRIPTION

Combination of an NPN transistor with low V_{CEsat} and high current capability and a planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package.

PNP complement: PMEM4010PD.

PINNING

PIN	DESCRIPTION	
1	emitter	
2	not connected	
3	cathode	
4	anode	
5	base	
6	collector	



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
NPN trans	istor			•	
V _{CBO}	collector-base voltage	open emitter	_	40	V
V _{CEO}	collector-emitter voltage	open base	_	40	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
Ic	collector current (DC)		_	1	Α
I _{CM}	peak collector current		_	2	Α
I _{BM}	peak base current		_	1	Α
Tj	junction temperature		_	150	°C
Schottky b	barrier diode			•	
V _R	continuous reverse voltage		_	20	V
I _F	continuous forward current		_	1	Α
I _{FSM}	non repetitive peak forward current t = 8.3 ms half sinewave; – JEDEC method		-	5	А
Tj	junction temperature – 125		125	°C	
Combined	l device				
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	600	mW
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	operating ambient temperature		-65	+125	°C

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air; note 1	208	K/W

Note

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².

^{1.} Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

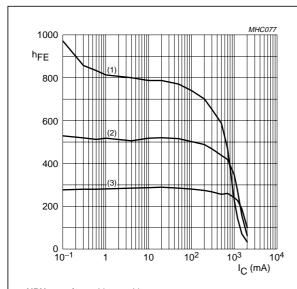
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
NPN trans	sistor			•	1	'
I _{CBO}	collector-base cut-off current	V _{CB} = 40 V; I _E = 0	_	-	100	nA
		V _{CB} = 40 V; I _E = 0; T _{amb} = 150 °C	_	-	50	μА
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	_	-	100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	_	Ī-	100	nA
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1 mA	300	-	_	
		V _{CE} = 5 V; I _C = 500 mA	300	Ī-	900	
		V _{CE} = 5 V; I _C = 1 A	200	Ī-	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 1 mA	_	-	80	mV
		I _C = 500 mA; I _B = 50 mA	_	1-	110	mV
		I _C = 1 A; I _B = 100 mA	_	Ī-	190	mV
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	_	-	1.2	V
R _{CEsat}	equivalent on-resistance	$I_C = 500 \text{ mA}$; $I_B = 50 \text{ mA}$; note 1	_	260	<220	mΩ
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 5 V; I _C = 1 A	_	Ī-	1.1	V
f _T	transition frequency	I _C = 50 mA; V _{CE} = 10 V; f = 100 MHz	150	_	_	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ ; } f = 1 \text{ MHz}$	_	-	10	pF
Schottky I	barrier diode			•	•	•
V _F	continuous forward voltage	I _F = 10 mA; note 1	_	240	270	mV
		I _F = 100 mA; note 1	_	300	350	mV
		I _F = 1000 mA; see Fig.7; note 1	_	480	550	mV
I _R	reverse current	V _R = 5 V; note 1	_	5	10	μА
		V _R = 8 V; note 1	_	7	20	μА
		V _R = 15 V; see Fig.8; note 1	_	10	50	μΑ
C _d	diode capacitance	V _R = 5 V; f = 1 MHz; see Fig.9	_	19	25	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

NPN transistor/Schottky diode module

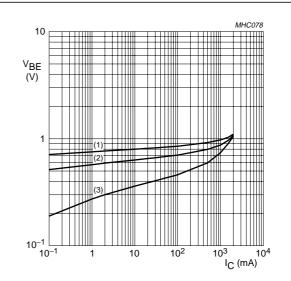
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NPN transistor; $V_{CE} = 5 \text{ V}$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

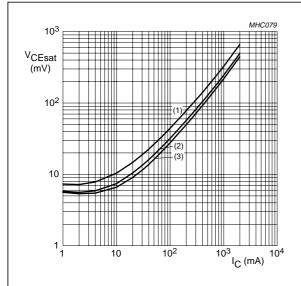
Fig.2 DC current gain as a function of collector current; typical values.



NPN transistor; $V_{CE} = 5 \text{ V}$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

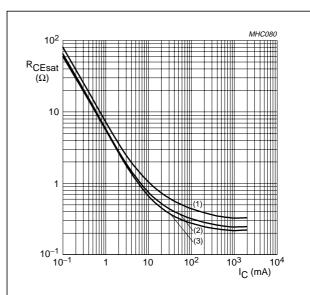
Fig.3 Base-emitter voltage as a function of collector current; typical values.



NPN transistor; $I_C/I_B = 10$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



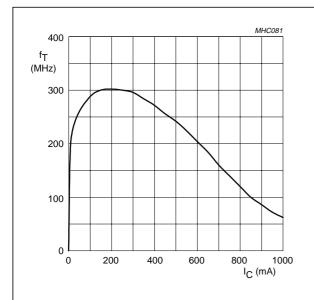
NPN transistor; $I_C/I_B = 10$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.5 Equivalent on-resistance as a function of collector current; typical values.

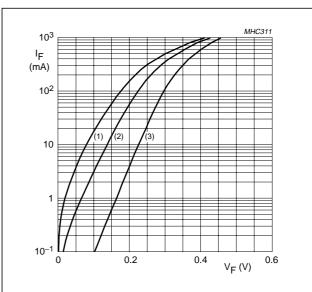
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NPN transistor; $V_{CE} = 10 \text{ V}.$

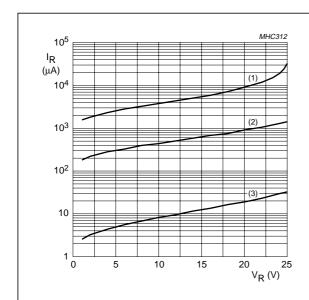
Fig.6 Transition frequency as a function of collector current.



Schottky barrier diode.

- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \,^{\circ}C$.

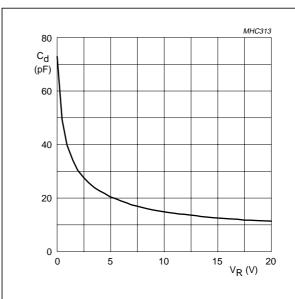
Fig.7 Forward current as a function of forward voltage; typical values.



Schottky barrier diode.

- (1) $T_{amb} = 125 \,^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \,^{\circ}C$.

Fig.8 Reverse current as a function of reverse voltage; typical values.



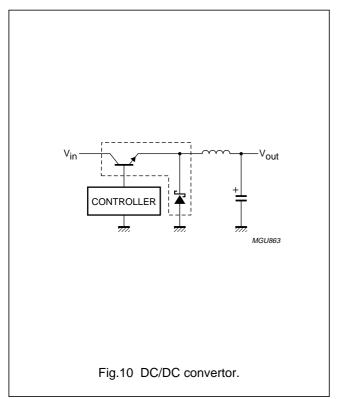
Schottky barrier diode; f = 1 MHz; T_{amb} = 25 °C.

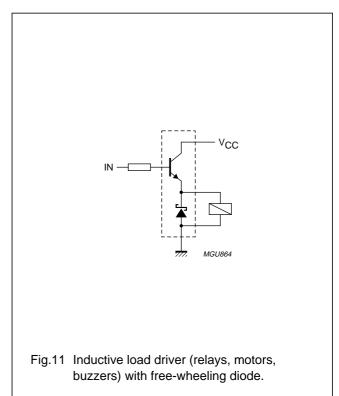
Fig.9 Diode capacitance as a function of reverse voltage; typical values.

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APPLICATION INFORMATION





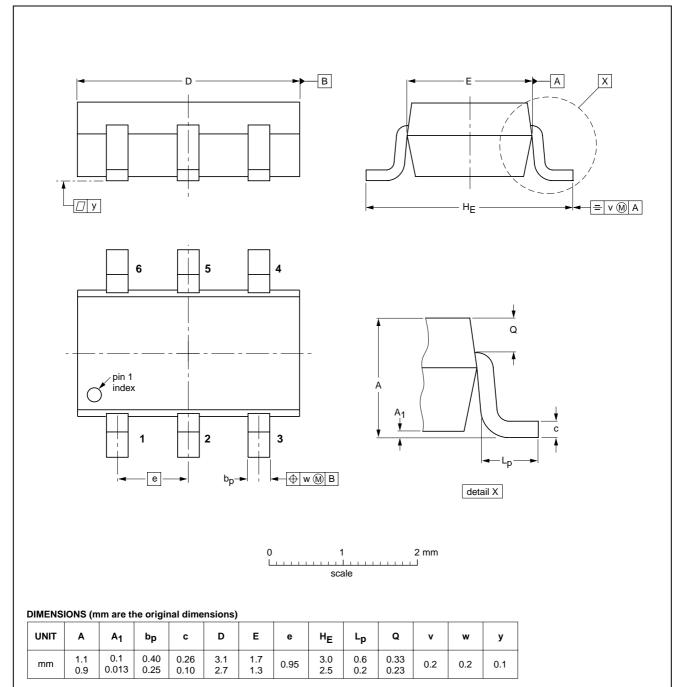
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457



EUROPEAN	ISSUE DATE	
PROJECTION	ISSUE DATE	
	97-02-28 01-05-04	

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
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NOTES

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NOTES

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